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on semiconductor® NDS8425

Single N-Channel, 2.5V Specified PowerTrench[®] MOSFET

General Description

This N-Channel 2.5V specified MOSFET is produced using ON Semiconductor's advanced Power Trench process that has been especially tailored to minimize on-state resistance and yet maintain low gate charge for superior switching performance.

These devices have been designed to offer exceptional power dissipation in a very small footprint package.

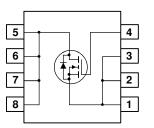
Applications

- DC/DC converter
- Load switch



Features

- 7.4 A, 20 V. $\begin{array}{l} R_{DS(ON)} = 0.022 \; \Omega \; @ \; V_{GS} = 4.5 \; V \\ R_{DS(ON)} = 0.028 \; \Omega \; @ \; V_{GS} = 2.7 \; V \end{array}$
- Fast switching speed
- Low gate charge (11nC typical)
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- High power and current handling capability in a widely used surface mount package



Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		20	V
V _{GSS}	Gate-Source Voltage		±8	V
ID	Drain Current – Continuous	(Note 1a)	±7.4	A
	- Pulsed		±20	
P _D	Power Dissipation for Single Operation	(Note 1a)	2.5	W
		(Note 1b)	1.2	
		(Note 1c)	1	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C
Therma	I Characteristics			
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	50	°C/W
R _{eJC}	Thermal Resistance, Junction-to-Case	(Note 1)	25	°C/W

Package Marking and Ordering Information

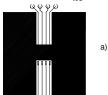
Device Marking	Device	Reel Size	Tape width	Quantity
NDS8425	NDS8425	13"	12mm	2500 units

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Publication Order Number: NDS8425/D

Electrical Characteristics $T_{A} = 25^{\circ}C$ unless otherwise noted Symbol Parameter Min Max Units **Test Conditions** Тур **Off Characteristics** Drain-Source Breakdown Voltage $V_{GS} = 0 V, I_D = 250 \mu A$ 20 V Breakdown Voltage Temperature $I_D = 250 \ \mu A$, Referenced to $25^{\circ}C$ 14 mV/°C Coefficient $V_{DS} = 16 V$, $V_{GS} = 0 V$ 1 Zero Gate Voltage Drain Current μA $V_{DS} = 16 V, V_{GS} = 0 V, T_{J} = 55^{\circ}C$ 10 Gate-Body Leakage, Forward $V_{GS} = 8 V$, $V_{\text{DS}} = 0 V$ 100 nA Gate-Body Leakage, Reverse $V_{GS} = -8 V$ $V_{DS} = 0 V$ -100 nA On Characteristics (Note 2) Gate Threshold Voltage $V_{\text{DS}} = V_{\text{GS}}, \, I_{\text{D}} = 250 \; \mu \text{A}$ V 0.4 0.89 1.5 Gate Threshold Voltage $I_D = 250 \ \mu A$, Referenced to $25^{\circ}C$ -3 mV/°C Temperature Coefficient $I_D = 7.4 \text{ A}$ $V_{GS} = 4.5 V,$ 15 Static Drain-Source 22 mΩ **On-Resistance** $V_{GS} = 4.5 \text{ V}, I_D = 7.4 \text{ A}, T_J = 125^{\circ}\text{C}$ 21 31 V_{GS}=2.7 V, I_D =7.2A 19 28 $V_{GS} = 4.5 V$, **On–State Drain Current** $V_{DS} = 5 V$ 20 А Forward Transconductance $V_{DS} = 5 V$, $I_{D} = 7.4 \text{ A}$ 31 S **Dynamic Characteristics** Input Capacitance 1098 pF $V_{DS} = 15 V$, $V_{GS} = 0 V$, **Output Capacitance** f = 1.0 MHz 240 pF **Reverse Transfer Capacitance** 115 pF Switching Characteristics (Note 2) Turn-On Delay Time $I_D = 1 A$, 9 18 $V_{DS} = 15 V$, ns $R_{\text{GEN}}=6~\Omega$ $V_{GS} = 4.5 V$, Turn-On Rise Time 13 24 ns Turn-Off Delay Time 26 42 ns Turn–Off Fall Time 11 20 ns **Total Gate Charge** $V_{DS} = 10 V$, $I_{D} = 7.4 \text{ A},$ 11 18 nC $V_{GS} = 4.5 V$ Gate-Source Charge 2.5 nC Gate-Drain Charge 3.1 nC Drain–Source Diode Characteristics and Maximum Ratings Maximum Continuous Drain-Source Diode Forward Current 1.9 А Drain-Source Diode Forward $V_{GS} = 0 V$, $I_{S} = 1.9 A$ 0.72 1.3 v (Note 2) Voltage 1. R_{0,JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of

the drain pins. $R_{_{\theta JC}}$ is guaranteed by design while $R_{_{\theta CA}}$ is determined by the user's board design.



Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%

BV_{DSS}

 ΔBV_{DSS}

 $\Delta T_{\rm J}$

IDSS

IGSSF

IGSSR

V_{GS(th)}

 $\Delta V_{GS(th)}$

 $\Delta T_{\rm J}$

R_{DS(on)}

I_{D(on)}

gfs

 C_{iss}

Coss

 C_{rss}

t_{d(on)}

t_{d(off)}

tr

tf Qg

Qas

 Q_{gd}

 I_{S}

 V_{SD}

Notes:

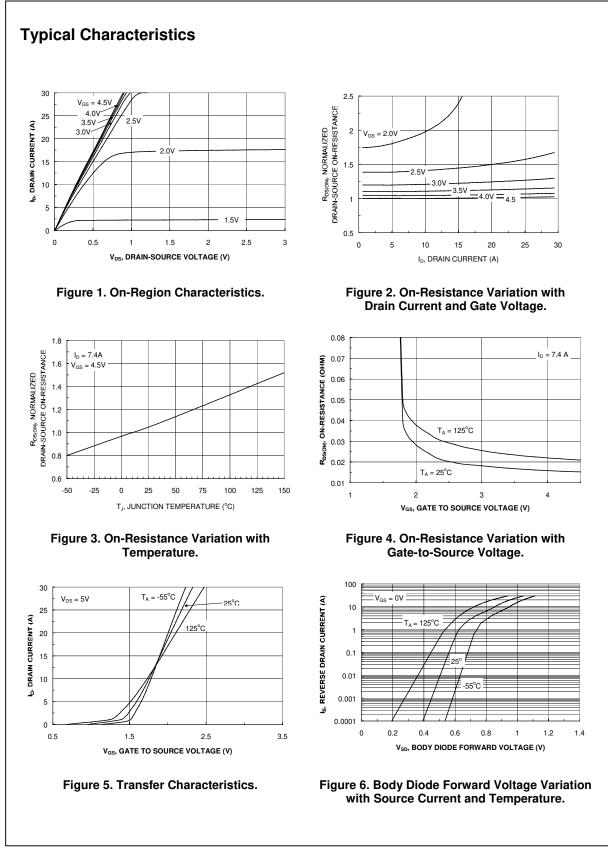
50°/W when
mounted on a 1 in ²
pad of 2 oz copper

αφφρ b) 105°/W when mounted on a .04 in² pad of 2 oz copper

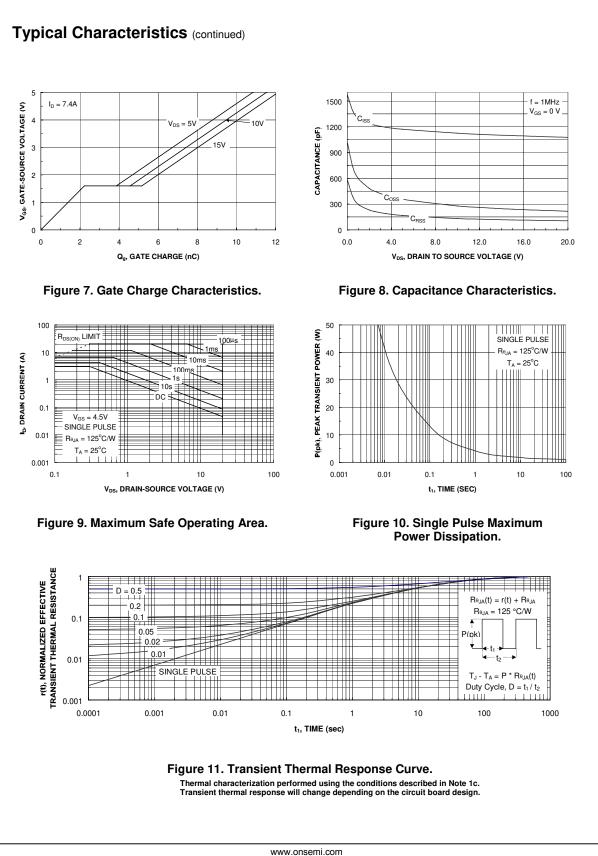
c) 125°/W when mounted on a minimum pad.

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